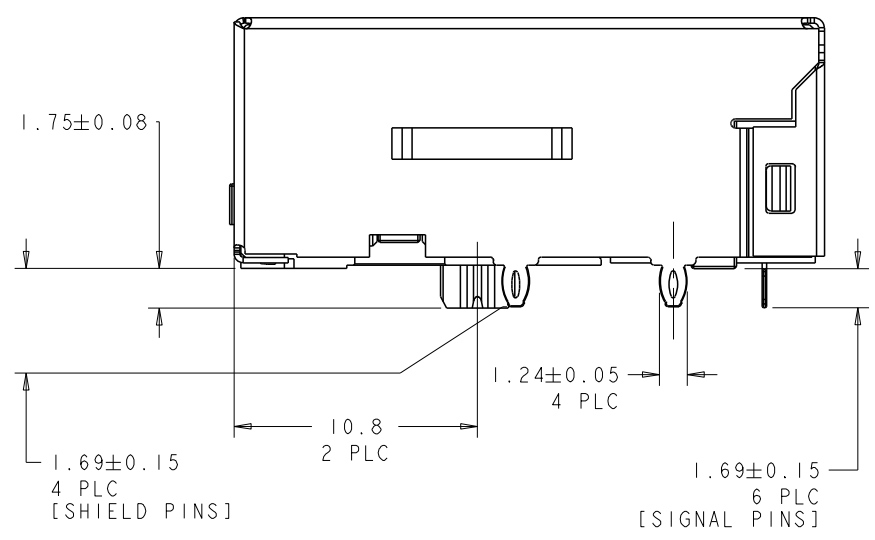
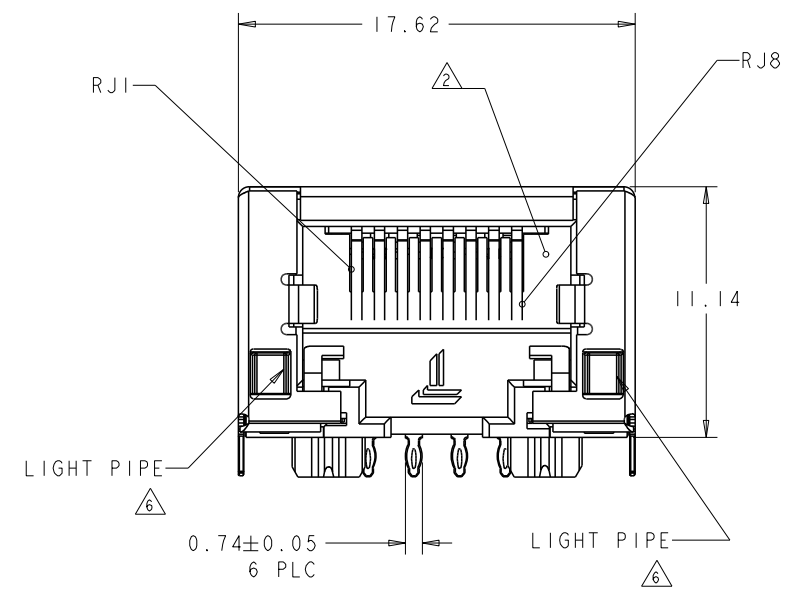
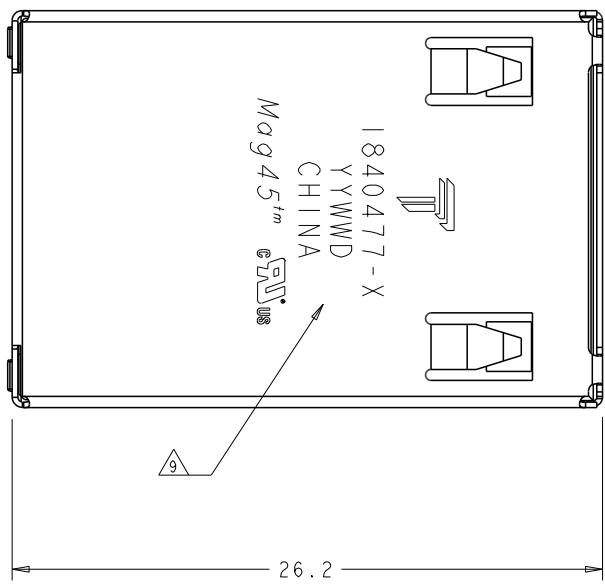
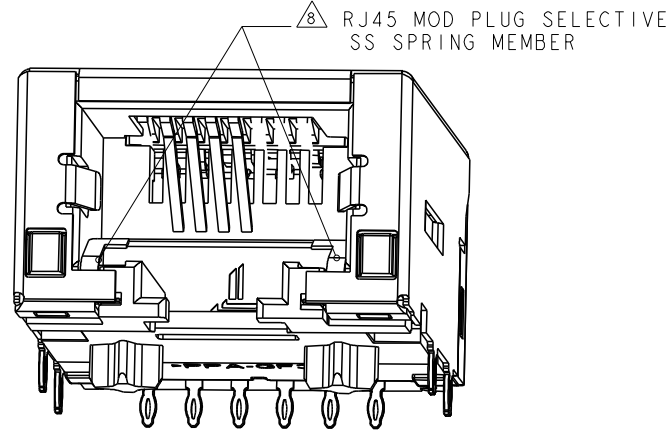


REVISIONS				
P	LV#	DESCRIPTION	DATE	APPD
2		LOGO CHANGE	25APR2013	TY KZ



- 1 MATERIALS:
 -HOUSING: HIGH TEMPERATURE NYLON, BLACK, UL 94V-0
 -SHIELD: 0.25mm THICK, BRASS PREPLATED WITH 0.76 μm MIN SEMI-BRIGHT NICKEL; POST-DIPPED WITH 2 μm MIN SAC 305 ALLOY LEAD FREE SOLDER (TIN PRIMARY, 3% SILVER, 0.5% COPPER)
 -CONTACT TAILS: 0.20mm THICK, PHOSPHOR BRONZE, 1.27 μm MIN OVERALL NICKEL UNDERPLATE, 3 μm MIN TIN PLATE
 -MOD JACK CONTACTS: 0.25mm THICK, PHOSPHOR BRONZE, 1.27 μm MIN OVERALL NICKEL UNDERPLATE, WITH 0.76 μm MIN LOCALIZED GOLD PLATE AT PLUG INTERFACE
 -LIGHT PIPE: POLYETHER SULFONE

2 RJ45 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUB-PART F.

- 3 MAGNETICS
 -APPLICATION: 10/100 BASE-T, EXTENDED TEMPERATURE
 -IMPEDANCE: 100 Ω
 -TURNS RATIO (CHIP:CABLE): TX = 1:1, RX = 1:1
 -OPEN CIRCUIT INDUCTANCE (OCL): 350μH MIN @100kHz, 0.1VRMS, 8mADC BIAS FROM -40°C TO +85°C, TX AND RX
 -PERFORMANCE @ 25°C:
 INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz
 RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 30MHz
 18-20LOG(f/30)dB MIN FROM 30.1MHz TO 60MHz
 12dB MIN FROM 60.1MHz TO 80MHz
 CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz
 33-20LOG(f/50)dB MIN FROM 40.1MHz TO 100MHz
 COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz
 -ISOLATION VOLTAGE: 2250VDC (MAX) FOR 60 SECONDS WITH A RISE TIME OF 500V/SEC)

4 THE MAGNETICS ARE ASYMMETRICAL, AND DO NOT SUPPORT AUTO-MDIX.

5 OPERATING TEMPERATURE: FROM -40°C TO +85°C.

6 LIGHT PIPES ARE USED TO TRANSMIT LIGHT OF SMD LED'S MOUNTED ON CUSTOMER BOARD.

7 ALL DIMENSIONS ARE NOMINAL UNLESS OTHERWISE NOTED.

8 RJ45 MOD PLUG SELECTIVE - THIS CONNECTOR UTILIZES STEEL SPRING MEMBER WHICH PREVENTS THE INSERTION OF A RJ11 (6 POSITION) PLUG INTO THE JACK PORT, WHILE ALLOWING A RJ45 (8 POSITION) PLUG TO MATE FREELY.

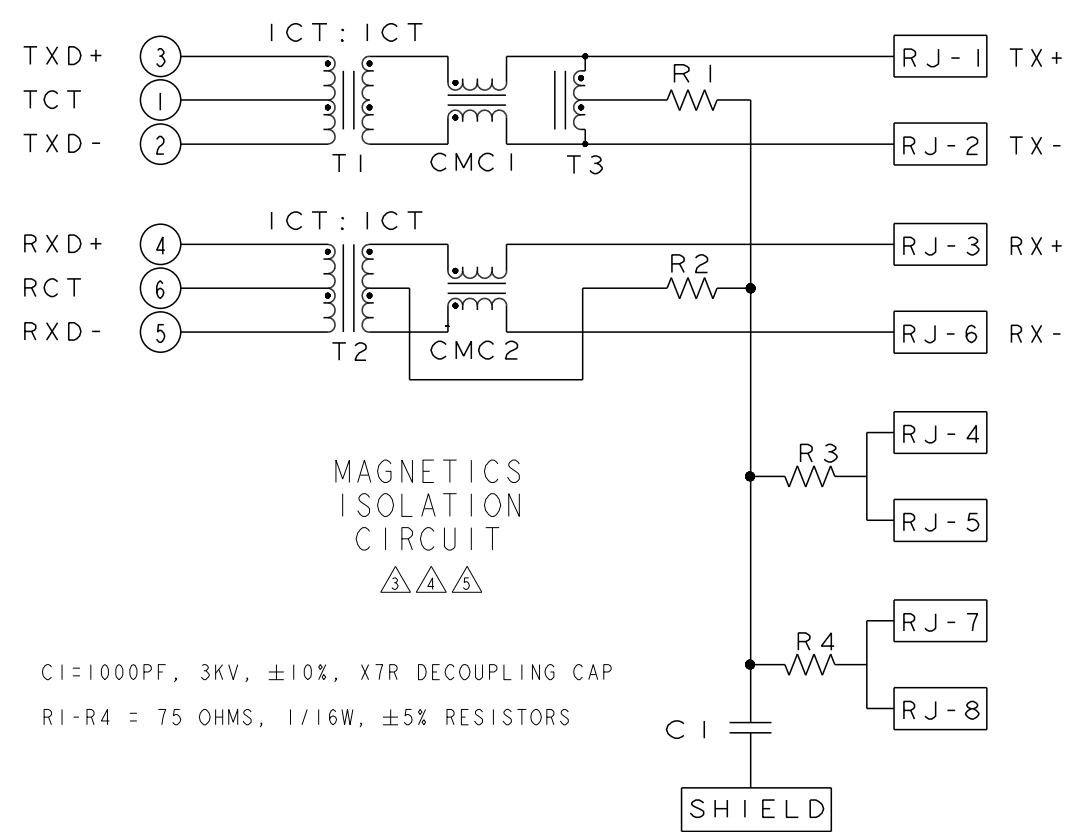
WARNING: THIS FEATURE WAS DEVELOPED FOR TYPICAL PLUG INSERTION FORCES. EXCESSIVE INSERTION FORCE MAY OVERCOME THE SELECTIVE FEATURES AND DAMAGE THE CONNECTOR.

9 TRADEMARK, PART NUMBER, DATE CODE, COUNTRY OF ORIGIN, AND AGENCY APPROVAL MARKING IN APPROXIMATE LOCATION SHOWN

10 1840477-1 SHOWN UNLESS OTHERWISE NOTED.

11 THESE PARTS ARE COMPLIANT WITH IR REFLOW SOLDERING PROCESS PEAK SOLDERING TEMPERATURE 260°C MAX DURATION TIME 10 SECONDS MAX, OVER 230°C WITHIN 40-60 SECONDS

814ET 10/100 BASE-T CIRCUIT



TOP AND SIDES	1840477-2
NONE	1840477-1
TABS	PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.

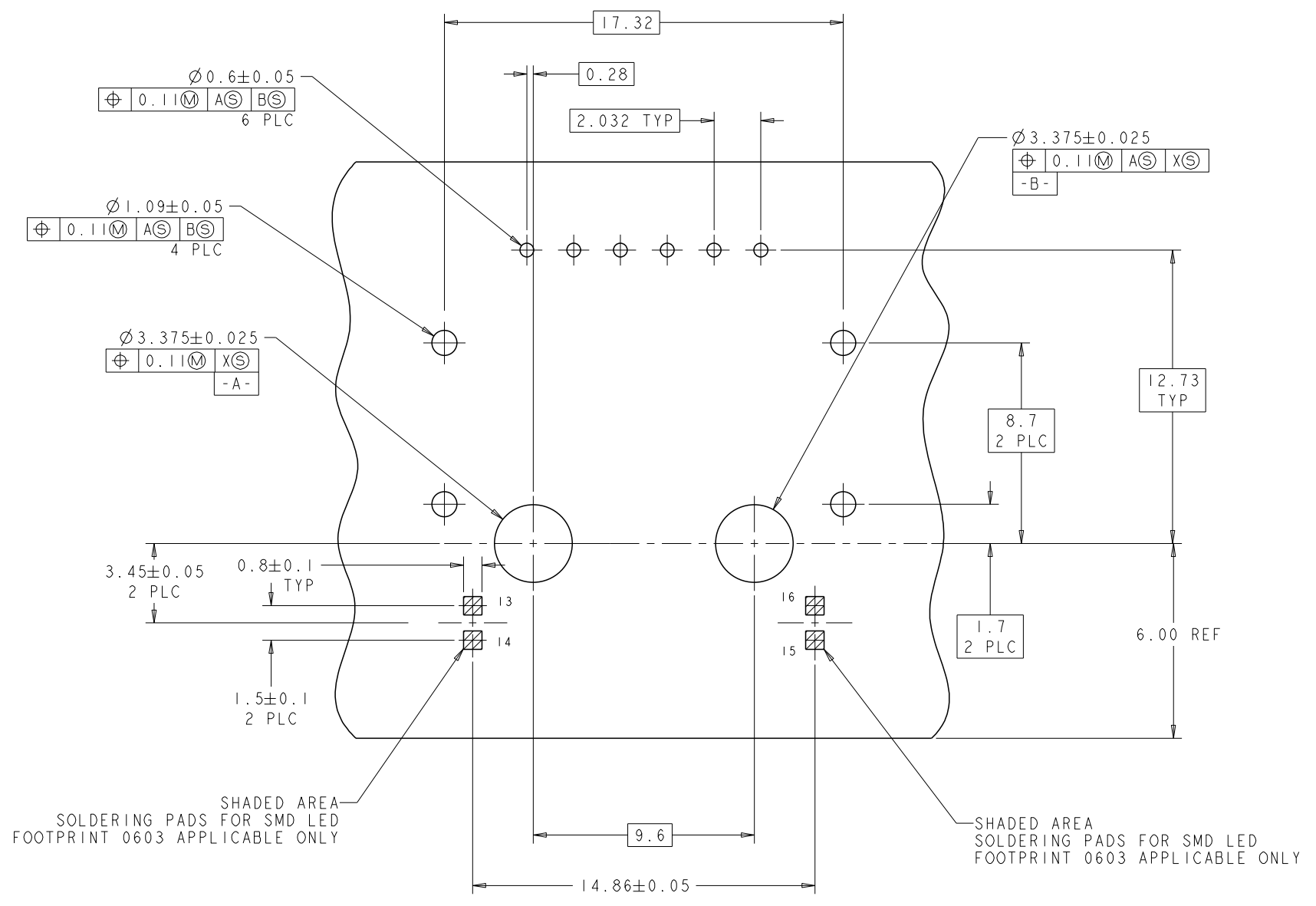
DRAWN: TOWER YU 09MAR2009	CHK: DENNIS CHEN 09MAR2009	APPRO: KEITH ZHU 09MAR2009
PRODUCT SPEC: 108-104009		
APPLICATION SPEC:		
DIMENSIONS: mm	TOLEANCES UNLESS OTHERWISE SPECIFIED:	
0 PLC ±	1 PLC ±0.25	2 PLC ±0.25
3 PLC ±	4 PLC ±	ANGLES ±
MATERIAL: 1	FINISH: 1	WEIGHT: -

TRP connector Dongguan China

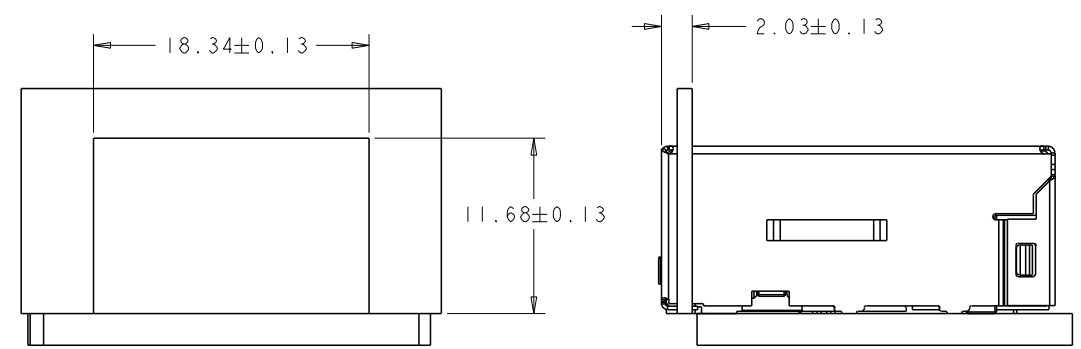
NAME: IXI MAG45(TM), MODULAR JACK, PRESS FIT, 814ET 10/100 CIRCUIT

SIZE: A1 CAGE CODE: 1840477 DRAWING NO: 1840477

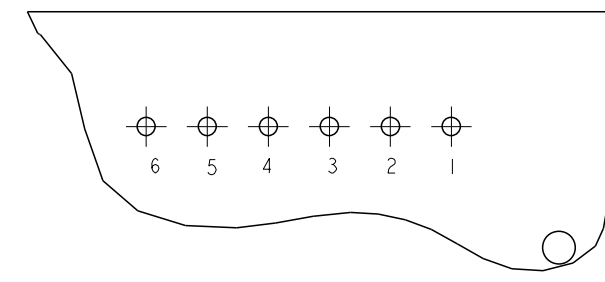
CUSTOMER DRAWING SCALE: NTS SHEET 1 OF 2 REV 2



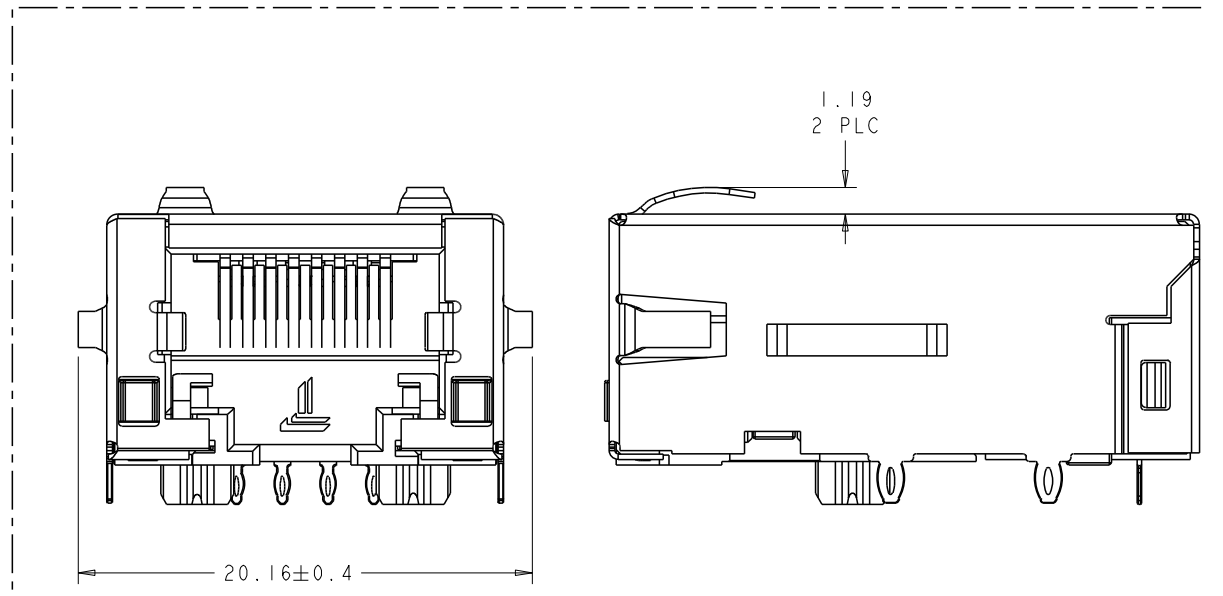
SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



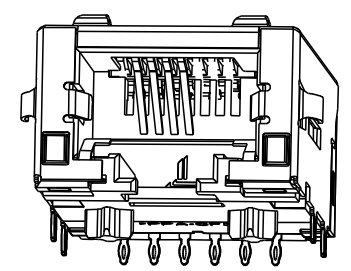
SUGGESTED PANEL OPENING



PIN DESIGNATIONS



1840477-2



SCALE 4:1

THIS DRAWING IS A CONTROLLED DOCUMENT.		DRN TOWER YU 09MAR2009	TRP connector Dongguan China
DIMENSIONS: mm		CHK DENNIS CHEN 09MAR2009	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPD KEITH ZHU 09MAR2009	
0 PLC	±	PRODUCT SPEC	NAME IXI MAG45(TM), MODULAR JACK, PRESS FIT, 814ET 10/100 CIRCUIT
1 PLC	±0.25	APPLICATION SPEC	SIZE A1
2 PLC	±0.25		CAGE CODE C=1840477
3 PLC	±		DRAWING NO 1840477
4 PLC	±		RESTRICTED TO
ANGLES	±		
MATERIAL		WEIGHT	
FINISH			
CUSTOMER DRAWING		SCALE NTS	SHEET 2 OF 2 REV 2